Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	4348	(polybutylene adj teraphthalate or pbt) and (polyurethane or silicone)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/12 07:34
S2	1297	(spray or immersion or dip or dipping) and S1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 15:29
S3	489	injection adj molding and S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/12 07:51
S4	83	(encapsulate or encapsulated or encapsulation) and S3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2005/05/12 07:36
S5	1	("4828901").URPN.	USPAT	OR	ON	2005/05/12 07:41
S6	1162	(spray or spraying) and S1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/12 07:51
S7	434	injection adj molding and S6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/12 07:51
S8	409	(heat or heating) and S7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/12 07:52

S9	146	(electronic or semiconductor or ic or integrated adj circuit or integrated adj chip) and S8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/12 07:52
S10	2	("4828901").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/12 08:07
S11	1	("4828901").URPN.	USPAT	OR	ON	2005/10/21 15:28
S12	4816	(polybutylene adj teraphthalate or pbt) and (polyurethane or silicone)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 15:29
S13	1444	(spray or immersion or dip or dipping) and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 15:29
S14	381932	coating and plastic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 15:30
S15	899	S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 15:30
S16	52	auburger.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:20
S17	166721	siemens.as.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:20

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S18	212210	encapsulate or encapsulated or encapsulation	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:21
S19	1759	S17 and S18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:21
S20	1958625	plastic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:21
S21	464	S19 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:21
S22	1112446	capacitor or resistor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:22
S23	98	S21 and S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:23
S24	2095433	resin	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:23
S25	28177	S18 and S20 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:24

636	2022	C22 4 C25	Tue perior		Ot:	2005/10/21 17 21
S26	2929	S22 and S25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:24
S27	138232	shrink adj tubing or shrink	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:24
S28	270	S26 and S27	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:36
S29	223	plastic adj protective adj cover	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:37
S30	. 17	S22 and S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:39
S31	5	S24 and S30	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:41
S32	22180	plastic adj cover or plastic adj covering	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:41
S33	173851	electronic adj component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:41

634		C22 4 C22	LIC DODUE	00	011	2005/10/21 15 15
S34	556	S32 and S33	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:42
S35	556	S20 and S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:46
S36	1807	resin adj encapsulated	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:46
S37	1	S32 and S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:47
538	19693 _.	potted	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:47
S39	143	S32 and S38	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 17:47
S40	2	("4791529").URPN.	USPAT	OR	ON	2005/10/21 17:56
S41	0	explosive adj proof adj capacitor	USPAT	OR	ON	2005/10/21 17:57
S42	0	explosive adj proof adj eletronic adj parts	USPAT	OR	ON	2005/10/21 17:57
S43	68	explosive adj proof	USPAT	OR	ON	2005/10/21 17:57
S44	10	S22 and S43	USPAT	OR	ON	2005/10/21 17:58
S45	1556	foil near4 capacitor	USPAT	OR	ON	2005/10/21 17:58
S46	516	S24 and S45	USPAT	OR	ON	2005/10/21 17:58
S47	4	S32 and S46	USPAT	OR	ON	2005/10/21 17:58

S48	404495	immerse or immersion or immersed	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:30
S49	19693	potted	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:30
S50	1663	S48 and S49	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:30
S51	1958625	plastic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:30
S52	793	S50 and S51	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:31
S53	1850997	coat or coating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:31
S54	403	S52 and S53	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:32
S55	709415	integrated adj circuit or electronic adj component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:32

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S56	73	S54 and S55	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:33
S57	78812	microelectronic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:33
S58	30240	S55 and S57	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:32
S59	3054	microelectronic adj component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:33
S60	8	S54 and S59	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/21 18:33
S61	8	("4203816" "4229274" "4672079" "4703338" "4789620" "4970135" "5151454" "5453451").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/21 18:37
S62	20	("4768286").URPN.	USPAT	OR	ON	2005/10/21 18:50
S63	1	explosion adj proof adj capacitor or explosive adj proof adj capacitor	USPAT	OR	ON	2005/10/21 18:50
S64	12	("4059848").URPN.	USPAT	OR	ON	2005/10/21 18:52
S65	6	("3553542" "4059848" "4342070" "4486809" "4661876").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/21 18:55
S66	425	disk adj capacitor	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/21 18:55
S67	6	S49 and S51 and S66	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/21 18:55

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S68	1503	shrink adj sleeve	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/22 15:32
S69	174099	electronic adj component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/22 15:30
S70	18	S68 and S69	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/22 15:30
S71	8	shrink adj sleeve near4 capacitor or shrink adj sleeve near4 resistor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/22 15:34
S72	285	mylar near4 capacitor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/22 15:34
S73	16	encapsulated and S72	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/22 15:35
S74	10	("4166286").URPN.	USPAT	OR	ON	2005/10/22 15:39
S75	21	comb adj conductor	USPAT	OR	ON	2005/10/22 15:39
S76	0	(encapsulating and (weld or welding) and plurality and comb). clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/11 11:40
S77	591	(438/112).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/11 11:41